MOSFET – Power, N-Channel, SUPERFET[®] III, FRFET[®] 650 V, 30 A, 110 mΩ

NVHL110N65S3F

Description

SUPERFET III MOSFET is ON Semiconductor's brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This advanced technology is tailored to minimize conduction loss, provide superior switching performance, and withstand extreme dv/dt rate.

Consequently, SUPERFET III MOSFET is very suitable for the various power system for miniaturization and higher efficiency.

SUPERFET III FRFET MOSFET's optimized reverse recovery performance of body diode can remove additional component and improve system reliability.

Features

- 700 V @ $T_J = 150^{\circ}C$
- Typ. $R_{DS(on)} = 93 \text{ m}\Omega$
- Ultra Low Gate Charge (Typ. $Q_g = 58 \text{ nC}$)
- Low Effective Output Capacitance (Typ. Coss(eff.) = 553 pF)
- 100% Avalanche Tested
- AEC-Q101 Qualified and PPAP Capable

Applications

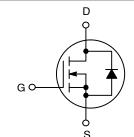
- Automotive On Board Charger HEV-EV
- Automotive DC/DC converter for HEV-EV



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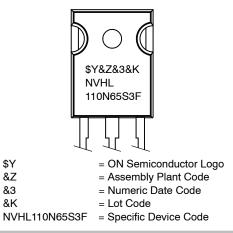
V _{DSS}	V _{DSS} R _{DS(on)} MAX	
650 V	110 m Ω @ 10 V	30 A



N-Channel MOSFET



MARKING DIAGRAM



ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

Symbol	Para	Value	Unit V	
V _{DSS}	Drain to Source Voltage			650
V _{GSS}	Gate to Source Voltage	DC	±30	V
		AC (f > 1 Hz)	±30	V
I _D	Drain Current	Continuous (T _C = 25°C)	30	А
		Continuous (T _C = 100°C)	19.5	
I _{DM}	Drain Current	Pulsed (Note 1)	69	А
E _{AS}	Single Pulsed Avalanche Energy (Note 2)		380	mJ
E _{AR}	Repetitive Avalanche Energy (Note 1)		2.4	mJ
dv/dt	MOSFET dv/dt		100	V/ns
	Peak Diode Recovery dv/dt (Note 3)		50	
PD	Power Dissipation	(T _C = 25°C)	240	W
		Derate Above 25°C	1.92	W/°C
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +150	°C
ΤL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 s		300	°C

ABSOLUTE MAXIMUM RATINGS (T_C = 25°C, Unless otherwise specified)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected. 1. Repetitive rating: pulse-width limited by maximum junction temperature. 2. $I_{AS} = 3.5 \text{ A}$, $R_G = 25 \Omega$, starting $T_J = 25^{\circ}C$. 3. $I_{SD} \le 15 \text{ A}$, di/dt $\le 200 \text{ A/}\mu$ s, $V_{DD} \le 400 \text{ V}$, starting $T_J = 25^{\circ}C$.

THERMAL CHARACTERISTICS

Symbol	Parameter	Value	Unit
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case, Max.	0.52	°C/W
R _{0JA}	Thermal Resistance, Junction to Ambient, Max.	40	

PACKAGE MARKING AND ORDERING INFORMATION

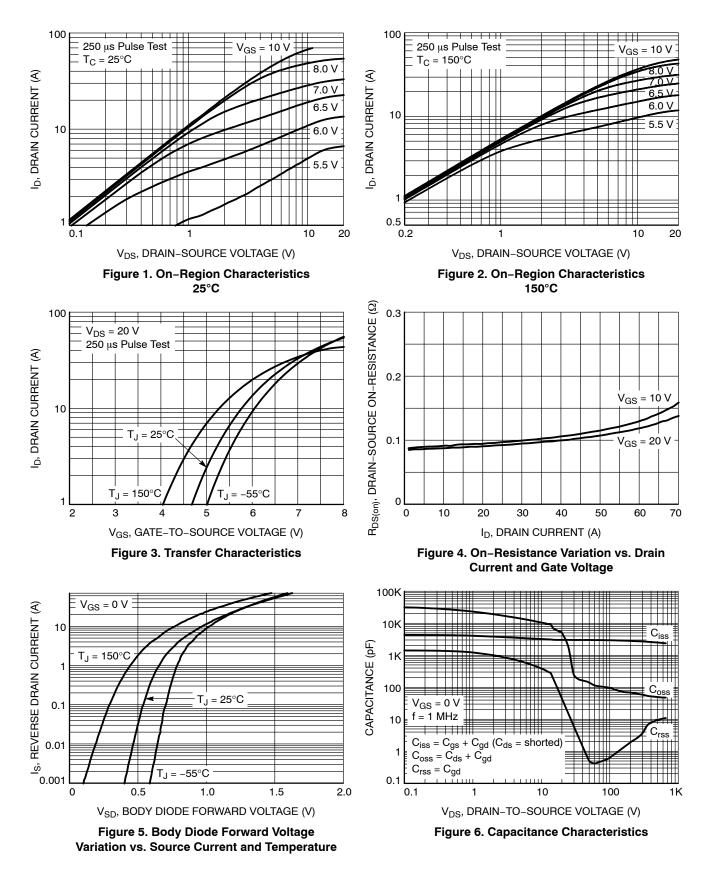
Part Number	Top Marking	Package	Packing Method	Reel Size	Tape Width	Quantity
NVHL110N65S3F	NVHL110N65S3F	TO-247	Tube	N/A	N/A	30 Units

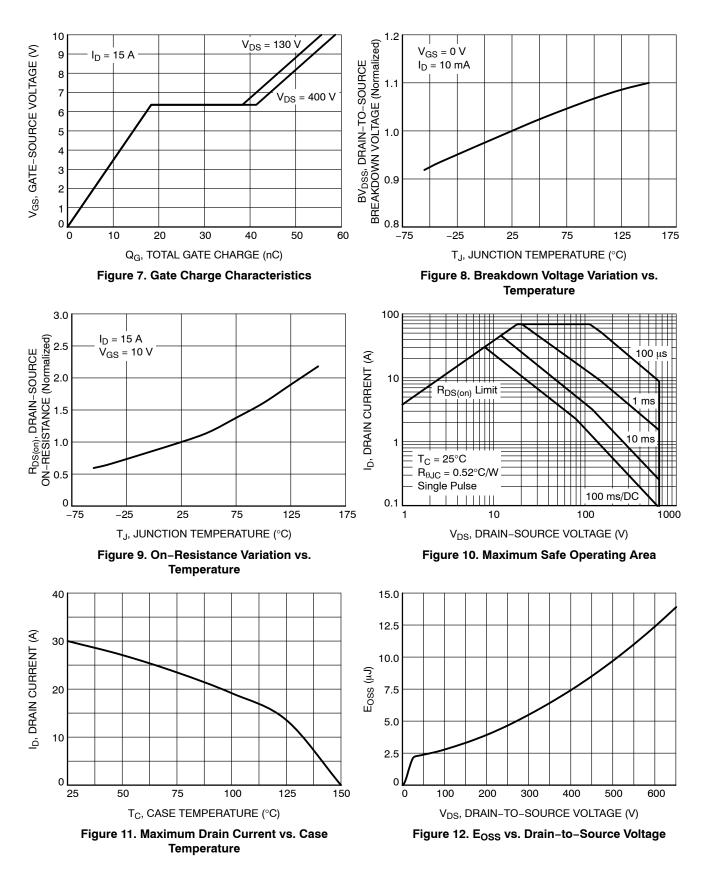
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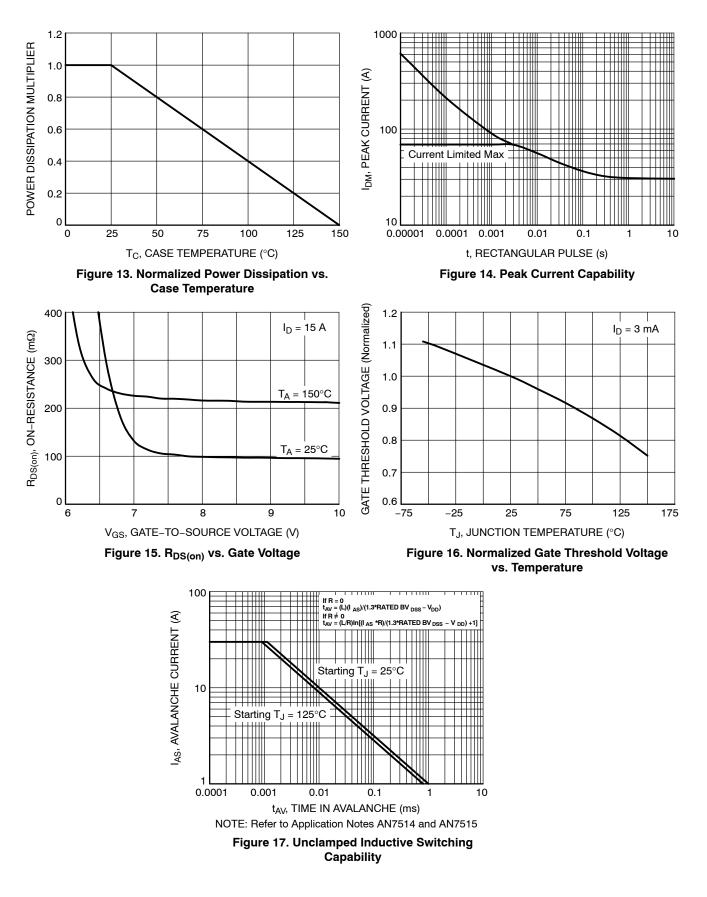
Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
OFF CHARACT	ERISTICS			1	•	
BV _{DSS} Drain to Source B	Drain to Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 1 \text{ mA}, \text{ T}_{J} = 25^{\circ}\text{C}$	650	-	-	V
		$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 10 \text{ mA}, \text{ T}_{J} = 150^{\circ}\text{C}$	700	-	_	V
$\Delta \text{BV}_{\text{DSS}} / \Delta \text{T}_{\text{J}}$	Breakdown Voltage Temperature Coefficient	I_D = 20 mA, Referenced to 25°C	-	0.61	-	V/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 650 \text{ V}, V_{GS} = 0 \text{ V}$	-	-	10	μA
		$V_{DS} = 520 \text{ V}, \text{ T}_{C} = 125^{\circ}\text{C}$	-	44	-	1
I _{GSS}	Gate to Body Leakage Current	$V_{GS} = \pm 30 \text{ V}, \text{V}_{DS} = 0 \text{ V}$	-	-	±100	nA
ON CHARACTE	RISTICS		•			
V _{GS(th)}	Gate Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 0.74 \text{ mA}$	3.0	-	5.0	V
R _{DS(on)}	Static Drain to Source On Resistance	V _{GS} = 10 V, I _D = 15 A	-	93	110	mΩ
9fs	Forward Transconductance	V _{DS} = 20 V, I _D = 15 A	-	17	_	S
DYNAMIC CHA	RACTERISTICS		•			
C _{iss}	Input Capacitance	V _{DS} = 400 V, V _{GS} = 0 V, f = 1 MHz	-	2560	-	pF
C _{oss}	Output Capacitance		-	50	-	pF
C _{oss(eff.)}	Effective Output Capacitance	V_{DS} = 0 V to 400 V, V_{GS} = 0 V	-	553	-	pF
C _{oss(er.)}	Energy Related Output Capacitance	V_{DS} = 0 V to 400 V, V_{GS} = 0 V	-	83	-	pF
Q _{g(tot)}	Total Gate Charge at 10 V	$V_{DS} = 400 \text{ V}, \text{ I}_{D} = 15 \text{ A}, \text{ V}_{GS} = 10 \text{ V}$	-	58	-	nC
Q _{gs}	Gate to Source Gate Charge	(Note 4)	-	19	_	nC
Q _{gd}	Gate to Drain "Miller" Charge		-	23	_	nC
ESR	Equivalent Series Resistance	f = 1 MHz	-	2	_	Ω
WITCHING CH	IARACTERISTICS	•	•			
t _{d(on)}	Turn-On Delay Time	$V_{DD} = 400 \text{ V}, I_D = 15 \text{ A},$	-	29	_	ns
t _r	Turn-On Rise Time	$V_{GS} = 10 \text{ V}, \text{ R}_{g} = 4.7 \Omega$ (Note 4)	-	32	_	ns
t _{d(off)}	Turn-Off Delay Time		-	61	-	ns
t _f	Turn-Off Fall Time	-	-	16	-	ns
SOURCE-DRAI	N DIODE CHARACTERISTICS	•				•
۱ _S	Maximum Continuous Source to Drain Diode Forward Current			-	30	Α
I _{SM}	Maximum Pulsed Source to Drain Diode Forward Current		-	-	69	Α
V _{SD}	Source to Drain Diode Forward Voltage	V _{GS} = 0 V, I _{SD} = 15 A	-	-	1.3	V
t _{rr}	Reverse Recovery Time	V _{GS} = 0 V, I _{SD} = 15 A,	-	94	-	ns
Q _{rr}	Reverse Recovery Charge	– dI _F /dt = 100 A/μs	_	343	_	nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 4. Essentially independent of operating temperature typical characteristics.

 Q_{rr}







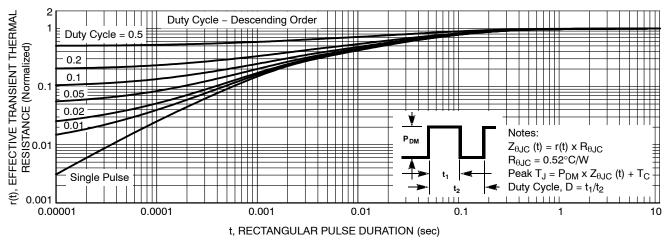


Figure 18. Transient Thermal Response

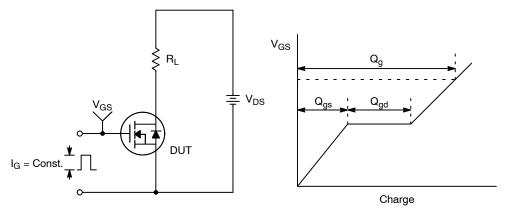


Figure 19. Gate Charge Test Circuit & Waveform

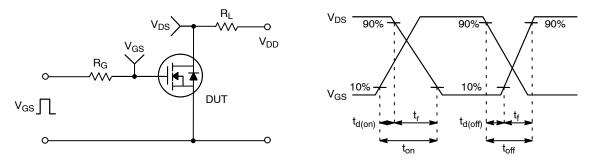


Figure 20. Resistive Switching Test Circuit & Waveforms

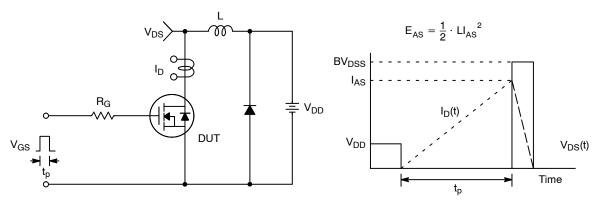


Figure 21. Unclamped Inductive Switching Test Circuit & Waveforms

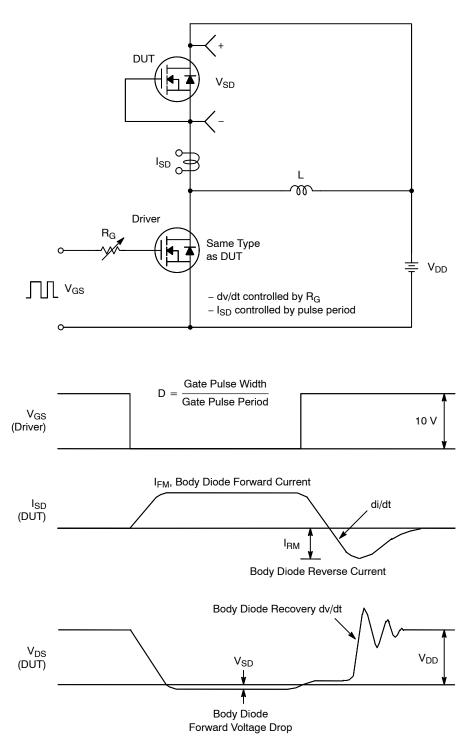
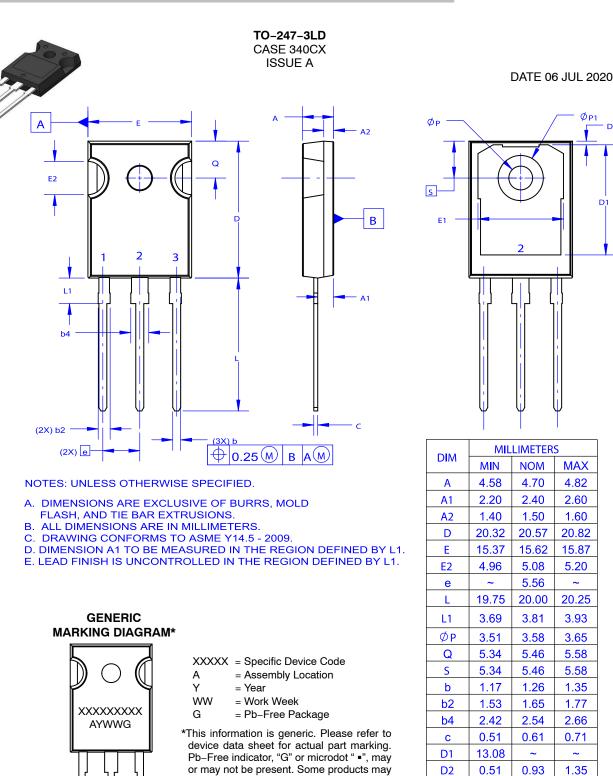


Figure 22. Peak Diode Recovery dv/dt Test Circuit & Waveforms

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